

1. General description

Silicon Carbide Schottky diode in a TO263-2L (D2PAK) plastic package, designed for high frequency switched-mode power supplies.



2. Features and benefits

- Highly stable switching performance
- High forward surge capability I_{FSM}
- Extremely fast reverse recovery time
- Superior in efficiency to Silicon Diode alternatives
- Reduced losses in associated MOSFET
- Reduced EMI
- Reduced cooling requirements
- RoHS compliant
- High junction operating temperature capability ($T_{j(max)} = 175\text{ °C}$)

3. Applications

- Power factor correction
- Telecom/Server SMPS
- UPS
- PV inverter
- PC Silverbox
- LED/OLED TV
- Motor Drives

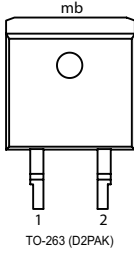
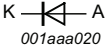
4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Notes	Values			Unit
Absolute maximum rating							
V_{RRM}	repetitive peak reverse voltage			1200			V
$I_{F(AV)}$	average forward current	$\delta = 0.5$; square-wave pulse; $T_{mb} \leq 145\text{ °C}$; Fig. 1 ; Fig. 2 ; Fig. 3		10			A
T_j	junction temperature			-55 to 175			°C
Symbol	Parameter	Conditions	Notes	Min	Typ	Max	Unit
Static characteristics							
V_F	forward voltage	$I_F = 10\text{ A}$; $T_j = 25\text{ °C}$; Fig. 5		-	1.42	1.60	V
		$I_F = 10\text{ A}$; $T_j = 150\text{ °C}$; Fig. 5		-	1.90	2.30	V
		$I_F = 10\text{ A}$; $T_j = 175\text{ °C}$; Fig. 5		-	2.00	2.50	V
Dynamic characteristics							
Q_r	recovered charge	$I_F = 10\text{ A}$; $di_F/dt = 500\text{ A}/\mu\text{s}$; $V_R = 400\text{ V}$; $T_j = 25\text{ °C}$; Fig. 7		-	22	-	nC

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode		
2	A	anode		
mb	mb	mounting base; connected to cathode		

6. Ordering information

Table 3. Ordering information

Type number	Package name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date
WNSC2D101200BT2	TO263-2L	WNSC2D101200BT26J	Reel	800	TO263N-2L	14-Oct-2022

7. Marking

Table 4. Marking codes

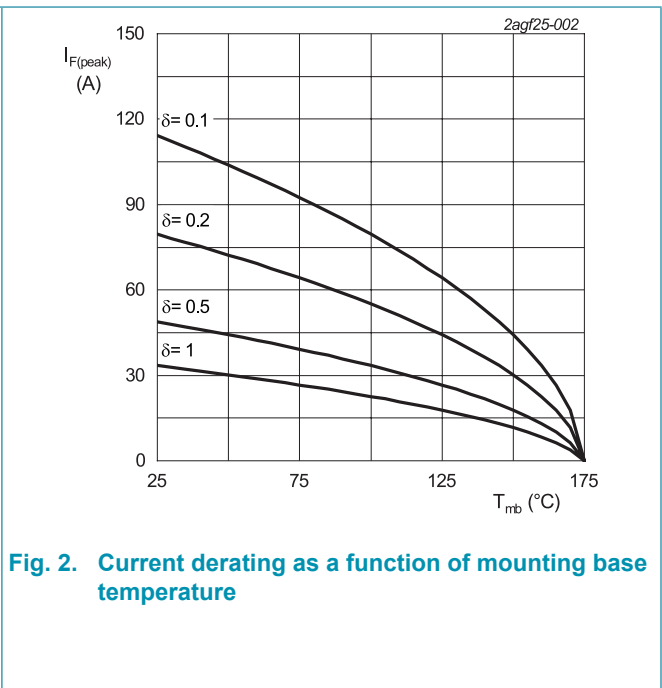
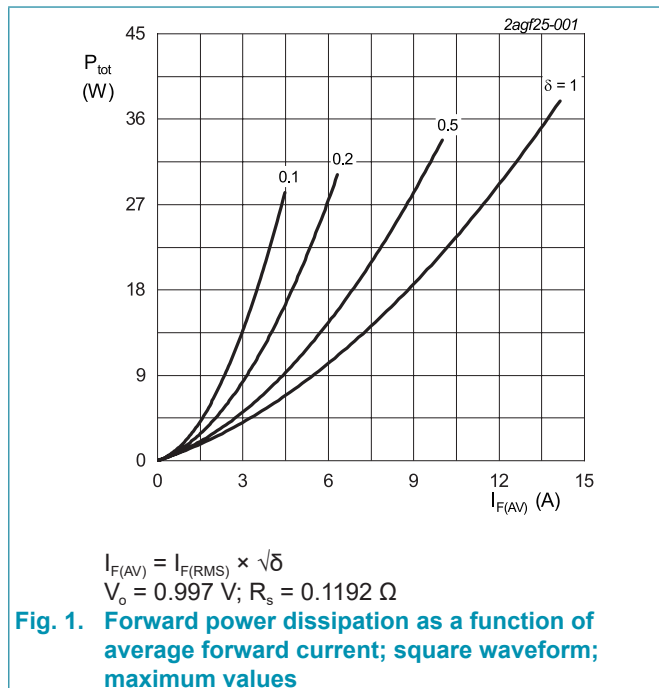
Type number	Marking codes
WNSC2D101200BT2	WNSC2D 101200BT2

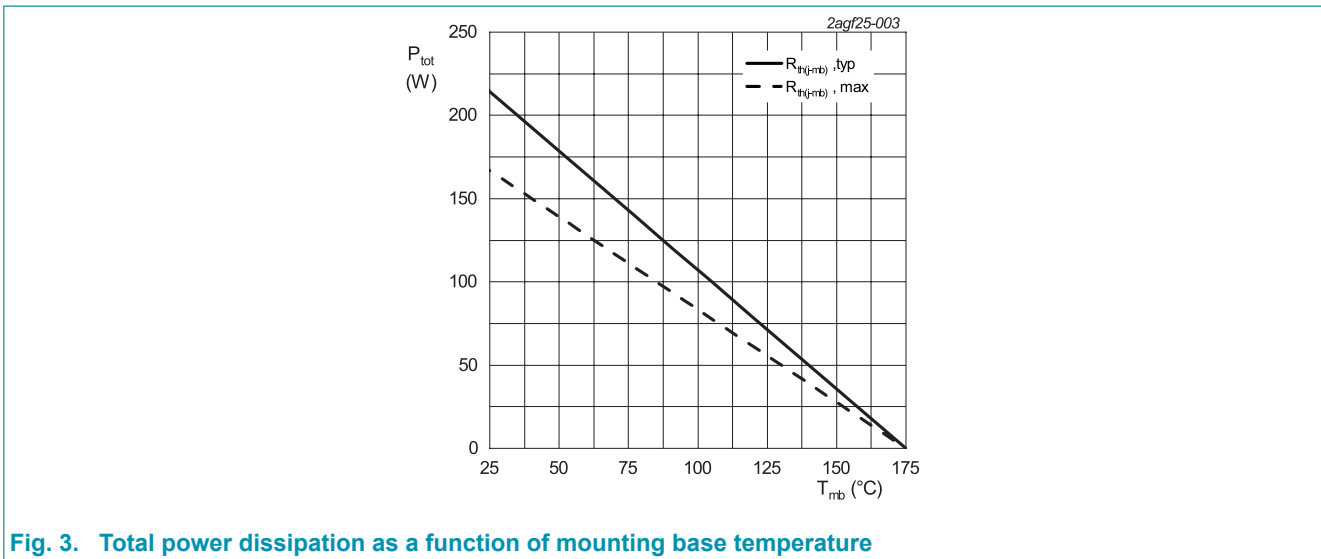
8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Notes	Values	Unit
V_{RRM}	repetitive peak reverse voltage			1200	V
V_{RWM}	crest working reverse voltage			1200	V
V_R	reverse voltage	DC		1200	V
$I_{F(AV)}$	average forward current	$\delta = 0.5$; square-wave pulse; $T_{mb} \leq 145\text{ }^\circ\text{C}$; Fig. 1 ; Fig. 2 ; Fig. 3		10	A
I_{FRM}	repetitive peak forward current	$\delta = 0.5$; $t_p = 25\text{ }\mu\text{s}$; $T_{mb} \leq 145\text{ }^\circ\text{C}$; square-wave pulse		20	A
I_{FSM}	non-repetitive peak forward current	$t_p = 10\text{ ms}$; $T_{j(\text{init})} = 25\text{ }^\circ\text{C}$; sine-wave pulse		80	A
		$t_p = 10\text{ }\mu\text{s}$; $T_{j(\text{init})} = 25\text{ }^\circ\text{C}$; square-wave pulse		700	A
I^2t	I^2t for fusing	sine-wave pulse; $T_{j(\text{init})} = 25\text{ }^\circ\text{C}$; $t_p = 10\text{ ms}$		32	A^2s
T_{stg}	storage temperature			-55 to 175	$^\circ\text{C}$
T_j	junction temperature			-55 to 175	$^\circ\text{C}$





9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Notes	Min	Typ	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	Fig. 4		-	0.7	0.9	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient free air	in free air		-	40	-	K/W

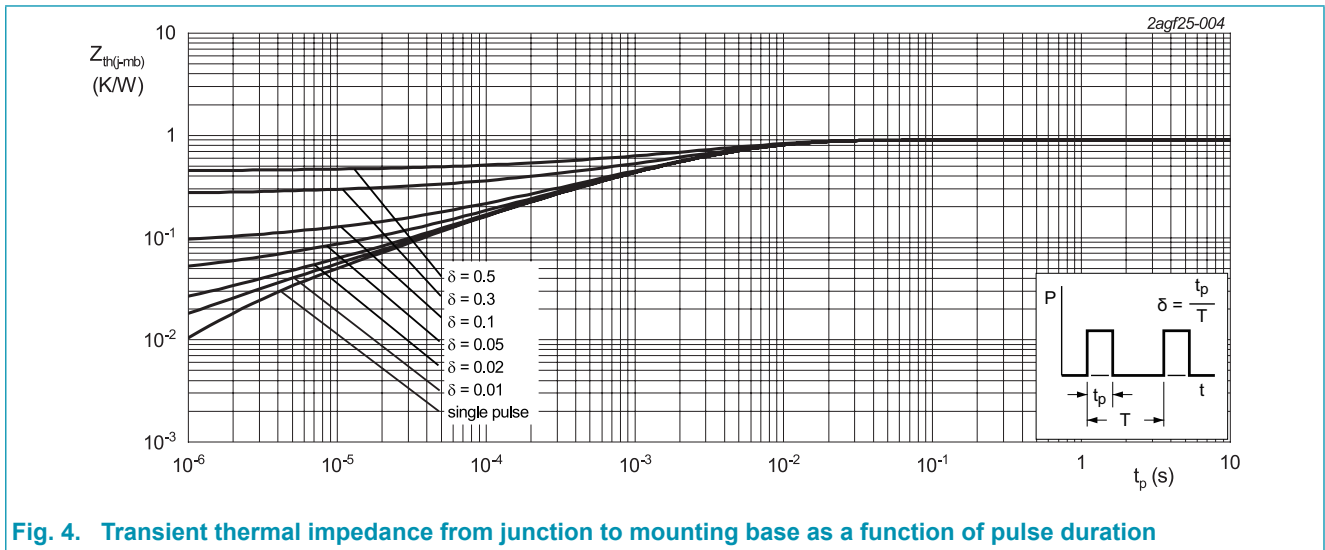
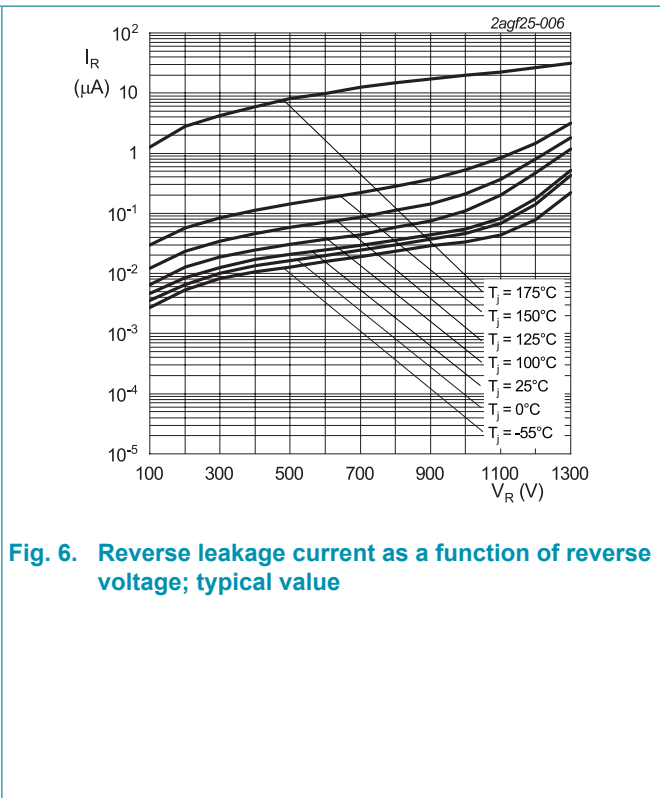
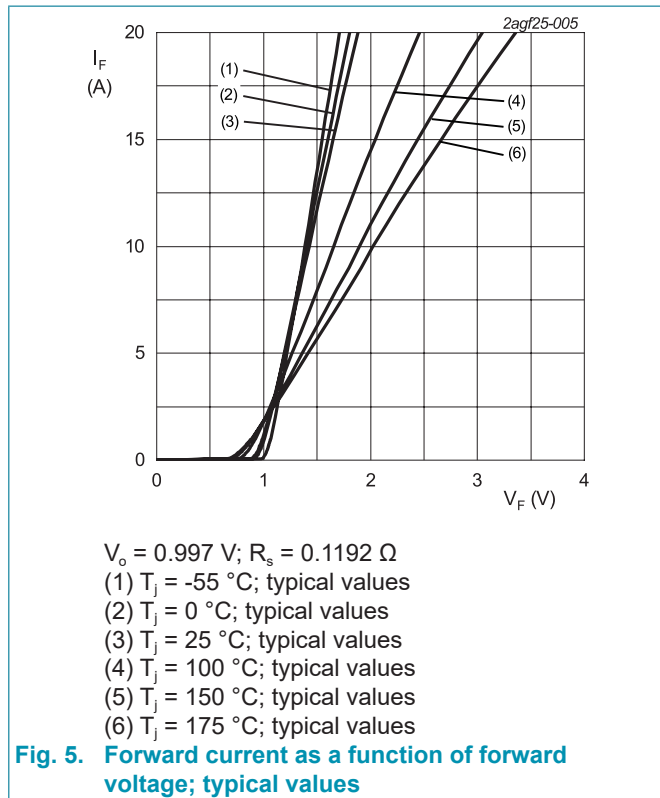


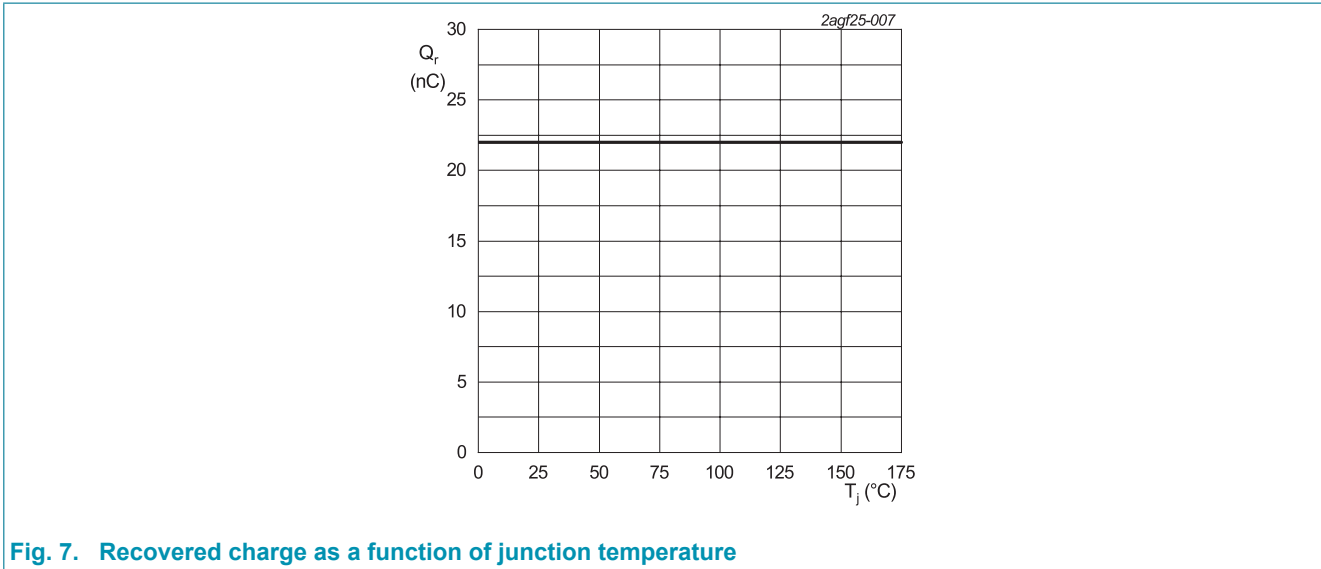
Fig. 4. Transient thermal impedance from junction to mounting base as a function of pulse duration

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Notes	Min	Typ	Max	Unit
Static characteristics							
V_F	forward current	$I_F = 10\text{ A}; T_j = 25\text{ °C}; \text{Fig. 5}$		-	1.42	1.60	V
		$I_F = 10\text{ A}; T_j = 150\text{ °C}; \text{Fig. 5}$		-	1.90	2.30	V
		$I_F = 10\text{ A}; T_j = 175\text{ °C}; \text{Fig. 5}$		-	2.00	2.50	V
I_R	reverse current	$V_R = 1200\text{ V}; T_j = 25\text{ °C}; \text{Fig. 6}$		-	1	50	μA
		$V_R = 1200\text{ V}; T_j = 175\text{ °C}; \text{Fig. 6}$		-	25	-	μA
Dynamic characteristics							
Q_r	recovered charge	$I_F = 10\text{ A}; V_R = 400\text{ V}; dI_F/dt = 500\text{ A}/\mu\text{s}; T_j = 25\text{ °C}; \text{Fig. 7}$		-	22	-	nC
C_d	diode capacitance	$f = 1\text{ MHz}; V_R = 1\text{ V}; T_j = 25\text{ °C}$		-	481	-	pF
		$f = 1\text{ MHz}; V_R = 400\text{ V}; T_j = 25\text{ °C}$		-	42	-	pF
		$f = 1\text{ MHz}; V_R = 800\text{ V}; T_j = 25\text{ °C}$		-	31	-	pF
E_{as}	non-repetitive avalanche energy	$I_R = 4.2\text{ A}; L = 10\text{ mH}; T_{j(\text{init})} = 25\text{ °C}$		88	-	-	mJ

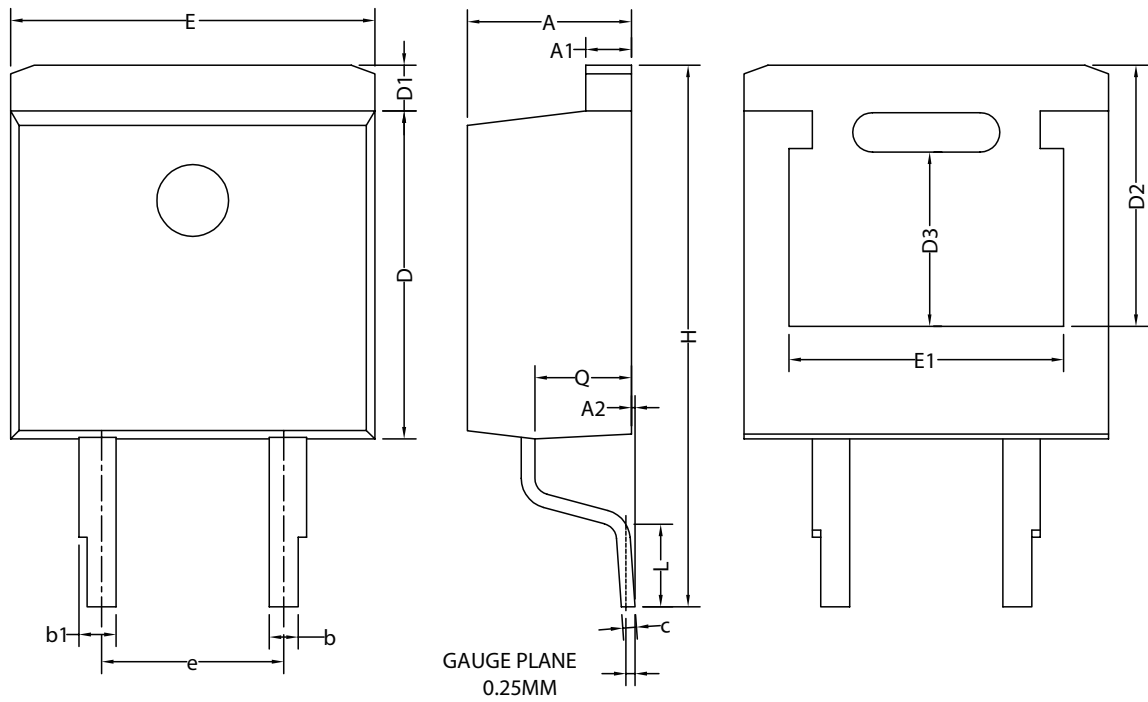




11. Package outline

Plastic single-ended surface-mounted package (D2PAK); 2 leads

TO263-2L



Note:
All dimensions do not include mold flash or protrusion.

Unit	A	A1	A2	b	b1	c	D	D1	D2	D3	e	E	E1	H	L	Q
MM	min	4.40	1.22	0.00	0.77	0.95	0.34	9.05	1.17	7.13	4.71	10.00	7.51	14.70	1.95	2.55
	max	4.70	1.36	0.25	0.90	1.15	0.47	9.35	1.40	7.43	5.01	10.26	7.81	15.50	2.60	2.79

12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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